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## **BIB DATA SHEET**

## **CONFIRMATION NO. 2189**

APPLICANTS James M. Derderian, Boise, ID;  *** CONTINUING DATA  *** FOREIGN APPLICATIONS  *** IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 09/28/2001  Foreign Priority claimed	SERIAL NUMBER	FILING or 371(c) DATE	CLASS	GROUP ART	UNIT	ATTORNEY DOCKET NO.	
APPLICANTS James M. Derderian, Boise, ID;  *** CONTINUING DATA **********************************	09/939,253		257	2826	226		
James M. Derderian, Boise, ID;  ** CONTINUING DATA *****  ** FOREIGN APPLICATIONS ************************************		RULE					
*** FOREIGN APPLICATIONS ************************************		derian, Boise, ID;					
** IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 09/28/2001  Foreign Priority claimed	** CONTINUING DA	TA ************	*				
Foreign Priority claimed	** FOREIGN APPLI	CATIONS ************************************	*****				
35 USC 119(a-d) conditions met		DREIGN FILING LICENS	E GRANTED **				
Acknowledged Examiner's Signature ID 4 102 6  ADDRESS  TRASK BRITT, P.C./ MICRON TECHNOLOGY P.O. BOX 2550 SALT LAKE CITY, UT 84110 UNITED STATES  TITLE  Semiconductor devices and semiconductor device assemblies including a nonconfluent spacer layer  FILING FEE RECEIVED 2426  FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:    D	35 USC 119(a-d) conditions r	net 🗆 Yes 🖬 No 📗 Met a					
TRASK BRITT, P.C./MICRON TECHNOLOGY P.O. BOX 2550 SALT LAKE CITY, UT 84110 UNITED STATES  TITLE  Semiconductor devices and semiconductor device assemblies including a nonconfluent spacer layer  FILING FEE RECEIVED 2426  FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:    All Fees			ID	4	102	6	
P.O. BOX 2550 SALT LAKE CITY, UT 84110 UNITED STATES  TITLE  Semiconductor devices and semiconductor device assemblies including a nonconfluent spacer layer  FILING FEE RECEIVED 2426  PEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:    All Fees     1.16 Fees (Filing)     1.17 Fees (Processing Ext. of time)     1.18 Fees (Issue)     Other     Other	ADDRESS		•			1	
FILING FEE RECEIVED 2426  Semiconductor devices and semiconductor device assemblies including a nonconfluent spacer layer    All Fees	P.O. BOX 255 SALT LAKE C	0 ITY, UT 84110	OLOGY				
FILING FEE RECEIVED 2426  FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:    All Fees	TITLE						
FILING FEE RECEIVED 2426  FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:  I.16 Fees (Filing)  I.17 Fees (Processing Ext. of time)  I.18 Fees (Issue)  Other	Semiconducto	r devices and semicondu	ctor device assemblies	including a nor	confluen <sup>.</sup>	t spacer layer	
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2426 No for following:   1.18 Fees (Issue)  Other					☐ 1.17 Fees (Processing Ext. of time)		
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